TPS706 150-mA, 6.5-V, 1-µA I_Q Voltage Regulators with Enable

1 Features

- Input Voltage Range: 2.7 V to 6.5 V
- Ultralow I_Q: 1 µA
- Reverse Current Protection
- Low I_{SHDN}: 150 nA
- Supports 200-mA Peak Output
- Low Dropout: 245 mV at 50 mA
- 2% Accuracy Over Temperature
- Available in Fixed-Output Voltages: 1.2 V to 5 V
- Thermal Shutdown and Overcurrent Protection
- Packages: SOT-23-5, WSON-6

2 Applications

- Smartphones and Tablets
- Portable and Battery-Powered Applications
- Camera Modules
- Set-Top Boxes
- Wearables
- Solid State Drives
- Medical Equipment

3 Description

The TPS706 series of linear voltage regulators are ultralow, quiescent current devices designed for power-sensitive applications. A precision band-gap and error amplifier provides 2% accuracy over temperature. Quiescent current of only 1 µA makes these devices ideal solutions for battery-powered, always-on systems that require very little idle-state power dissipation. These devices have thermal-shutdown, current-limit, and reverse-current protection for added safety.

These regulators can be put into shutdown mode by pulling the EN pin low. The shutdown current in this mode goes down to 150 nA, typical.

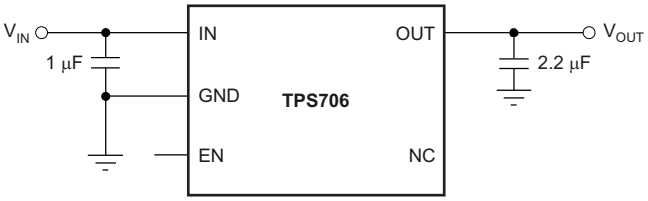
The TPS706 series is available in WSON-6 and SOT-23-5 packages.

Device Information(1)

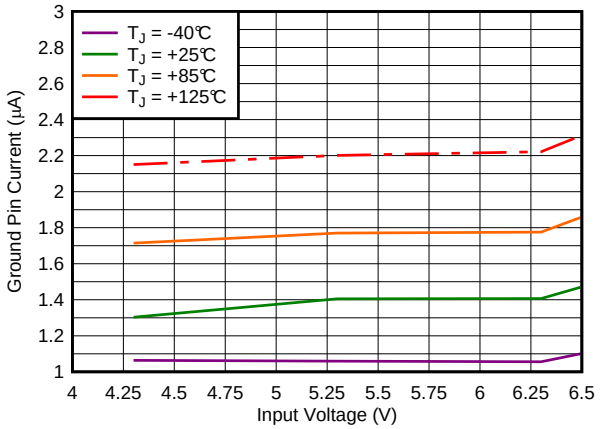
PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS706	SOT-23 (5)	2.90 mm × 1.60 mm
	WSON (6)	2.00 mm × 2.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Typical Application Circuit



GND Current vs V_{IN} and Temperature



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

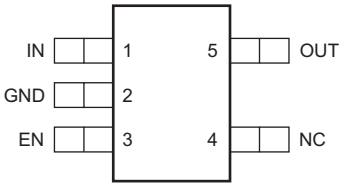
Changes from Original (October 2014) to Revision A **Page**

- Made changes to product preview data sheet; released as Production Data ... 1

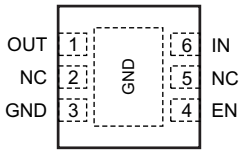
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5 Pin Configuration and Functions

DBV Package
SOT-23-5
(Top View)



DRV Package
WSON-6
(Top View)



Pin Functions

PIN			I/O	DESCRIPTION
NAME	NO. DRV	NO. DBV		
EN	4	3	I	Enable pin. Driving this pin high enables the device. Driving this pin low puts the device into low current shutdown. This pin can be left floating to enable the device. The maximum voltage must remain below 6.5 V.
GND	3	2	—	Ground
IN	6	1	I	Unregulated input to the device
NC	2, 5	4	—	No internal connection
OUT	1	5	O	Regulated output voltage. Connect a small 2.2-µF or greater ceramic capacitor from this pin to ground to assure stability.
Thermal pad		—	—	The thermal pad is electrically connected to the GND node. Connect to the GND plane for improved thermal performance.

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6 Specifications

6.1 Absolute Maximum Ratings

specified at T_J = –40°C to 125°C, unless otherwise noted; all voltages are with respect to GND(1)

		MIN	MAX	UNIT
Voltage	V_{IN}	–0.3	7	V
	V_{EN}	–0.3	7	V
	V_{OUT}	–0.3	7	V
Maximum output current	I_{OUT}	Internally limited		
Output short-circuit duration		Indefinite		
Continuous total power dissipation	P_{DISS}	See *Thermal Information*		
Junction temperature, T_J		–55	150	°C
Storage temperature, T_{stg}		–55	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001(1)	±2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101(2)	±500	

(1) JEDEC document JEP155 states that 2-kV HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 500-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V_{IN}	Input voltage	2.7		6.5	V
V_{OUT}	Output voltage	1.2		5	V
I_{OUT}	Output current	0		150	mA
V_{EN}	Enable voltage	0		6.5	V
C_{IN}	Input capacitor	0	1		µF
C_{OUT}	Output capacitor	2	2.2	47	µF
T_J	Operating junction temperature	–40		125	°C

6.4 Thermal Information

THERMAL METRIC(1)		TPS706		UNIT
		DBV	DRV	
		5 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	212.1	73.1	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	78.5	97.0	
$R_{\theta JB}$	Junction-to-board thermal resistance	39.5	42.6	
ψ_{JT}	Junction-to-top characterization parameter	2.86	2.9	
ψ_{JB}	Junction-to-board characterization parameter	38.7	42.9	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	N/A	12.8	

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

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6.5 Electrical Characteristics

At T_J = –40°C to 125°C, V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), I_{OUT} = 1 mA, V_{EN} = 2 V, and C_{IN} = C_{OUT} = 2.2-µF ceramic, unless otherwise noted. Typical values are at T_J = 25°C.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IN}	Input voltage range		2.7		6.5	V
V_{OUT}	Output voltage range		1.2		5.0	V
$V_{OUT(accuracy)}$	DC output accuracy	V_{OUT} < 3.3 V	–2%		2%	
		V_{OUT} ≥ 3.3 V, T_J = –40°C to 85°C	–1%		1%	
ΔV_{OUT}	Line regulation	($V_{OUT(nom)}$ + 1 V, 2.7 V) ≤ V_{IN} ≤ 6.5 V		3	10	mV
	Load regulation	V_{IN} = $V_{OUT(nom)}$ + 1.5 V or 3 V (whichever is greater), 100 µA ≤ I_{OUT} ≤ 150 mA		20	50	mV
V_{DO}	Dropout voltage(1)(2)	2.8 V ≤ V_{OUT} ≤ 3.3 V, I_{OUT} = 50 mA		295	650	mV
		2.8 V ≤ V_{OUT} ≤ 3.3 V, I_{OUT} = 150 mA		975	1540	mV
$I_{(CL)}$	Output current limit(3)	V_{OUT} = 0.9 × $V_{OUT(nom)}$	200	320	500	mA
I_{GND}	Ground pin current	I_{OUT} = 0 mA, V_{OUT} ≤ 3.3 V		1.3	2.55	µA
		I_{OUT} = 150 mA		350		µA
I_{SHDN}	Shutdown current	V_{EN} ≤ 0.4 V, V_{IN} = 2.7 V		150		nA
PSRR	Power-supply rejection ratio	f = 10 Hz		80		dB
		f = 100 Hz		62		dB
		f = 1 kHz		52		dB
V_n	Output noise voltage	BW = 10 Hz to 100 kHz, I_{OUT} = 10 mA, V_{IN} = 2.7 V, V_{OUT} = 1.2 V		190		μV_{RMS}
$V_{EN(HI)}$	Enable pin high (enabled)		0.9			V
	Enable pin high (disabled)		0		0.4	V
I_{EN}	EN pin current	EN = 1.0 V, V_{IN} = 5.5 V		300		nA
I_{REV}	Reverse current (flowing out of IN pin)	V_{OUT} = 3 V, V_{IN} = V_{EN} = 0 V		10		nA
	Reverse current (flowing into OUT pin)	V_{OUT} = 3 V, V_{IN} = V_{EN} = 0 V		100		nA
T_{SD}	Thermal shutdown temperature	Shutdown, temperature increasing		158		°C
		Reset, temperature decreasing		140		°C
T_J	Operating junction temperature		–40		125	°C

(1) V_{DO} is measured with V_{IN} = 0.98 × $V_{OUT(nom)}$.
(2) Dropout is only valid when V_{OUT} ≥ 2.8 V because of the minimum input voltage limits.
(3) Measured with V_{IN} = V_{OUT} + 3 V for V_{OUT} ≤ 2.5 V. Measured with V_{IN} = V_{OUT} + 2.5 V for V_{OUT} > 2.5 V.

6.6 Timing Requirements

At T_J = –40°C to 125°C, V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), R_L = 47 Ω, V_{EN} = 2 V, and C_{IN} = C_{OUT} = 2.2-µF ceramic, unless otherwise noted. Typical values are at T_J = 25°C.

PARAMETER			MIN	TYP	MAX	UNIT
t_{STR}	Start-up time(1)	$V_{OUT(nom)}$ ≤ 3.3 V		200	600	µs
		V_{OUT} > 3.3 V		500	1500	µs

(1) Startup time = time from EN assertion to 0.95 × $V_{OUT(nom)}$ and load = 47 Ω.

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6.7 Typical Characteristics

Over operating temperature range (T_J = –40°C to 125°C), I_{OUT} = 10 mA, V_{EN} = 2 V, C_{OUT} = 2.2 µF, and V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), unless otherwise noted. Typical values are at T_J = 25°C.

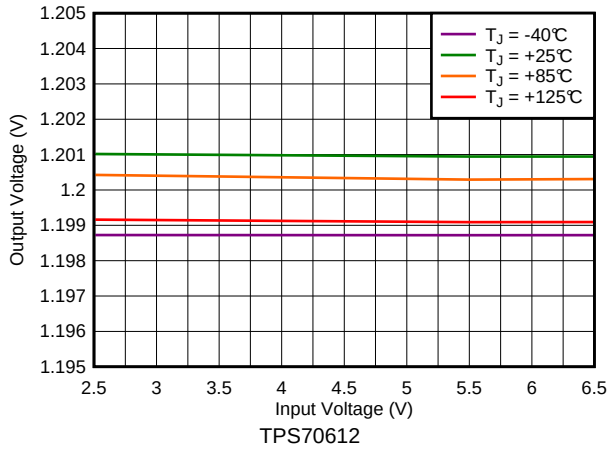


Figure 1. 1.2-V Line Regulation vs V_{IN} and Temperature

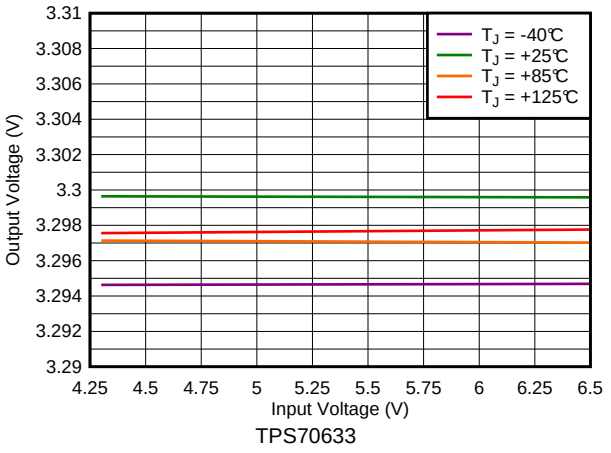


Figure 2. 3.3-V Line Regulation vs V_{IN} and Temperature

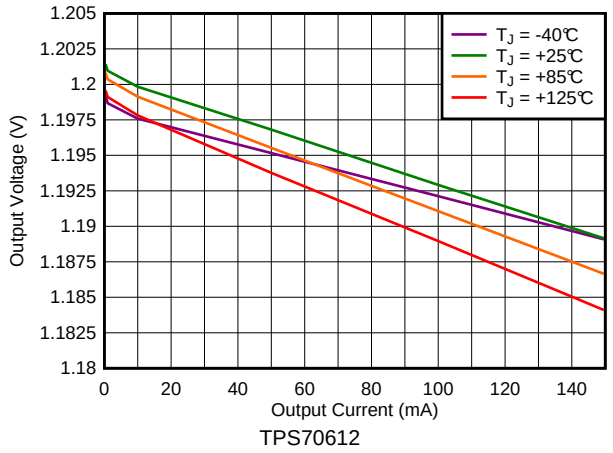


Figure 3. 1.2-V Load Regulation vs I_{OUT} and Temperature

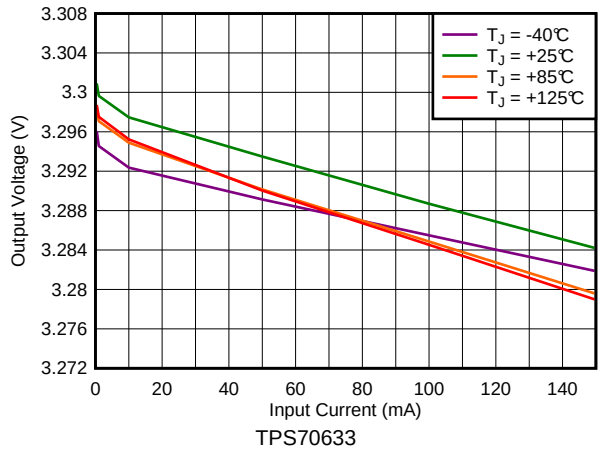


Figure 4. 3.3-V Load Regulation vs I_{OUT} and Temperature

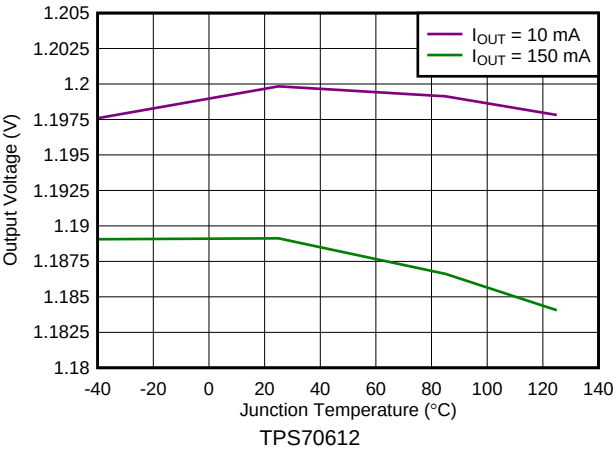


Figure 5. V_{OUT} vs Temperature

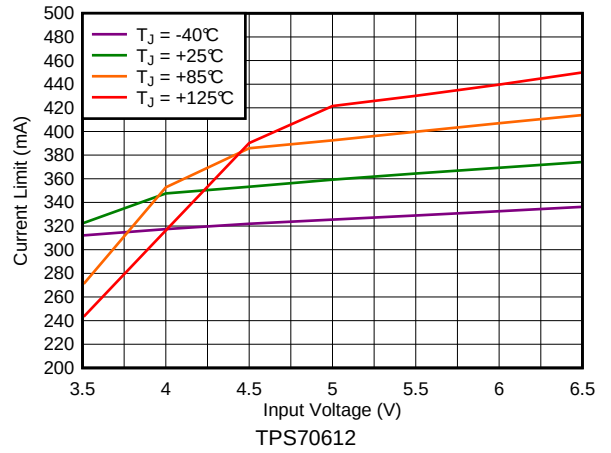


Figure 6. 1.2-V Current Limit vs V_{IN} and Temperature

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Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), I_{OUT} = 10 mA, V_{EN} = 2 V, C_{OUT} = 2.2 µF, and V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), unless otherwise noted. Typical values are at T_J = 25°C.

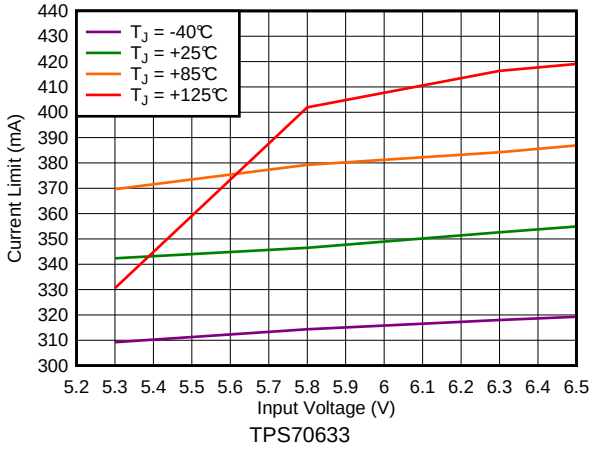


Figure 7. 3.3-V Current Limit vs V_{IN} and Temperature

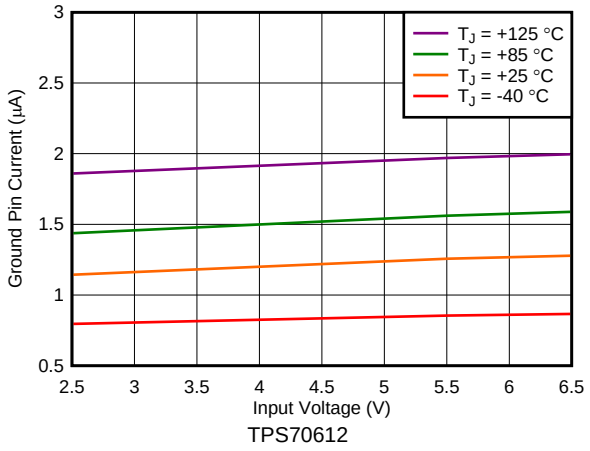


Figure 8. GND Current vs V_{IN} and Temperature

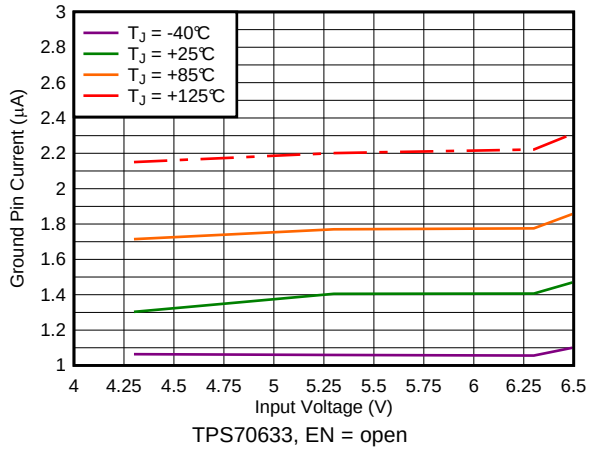


Figure 9. GND Current vs V_{IN} and Temperature

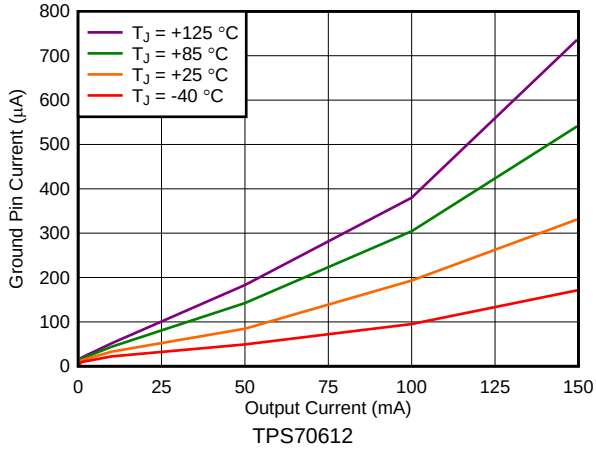


Figure 10. GND Current vs I_{OUT} and Temperature

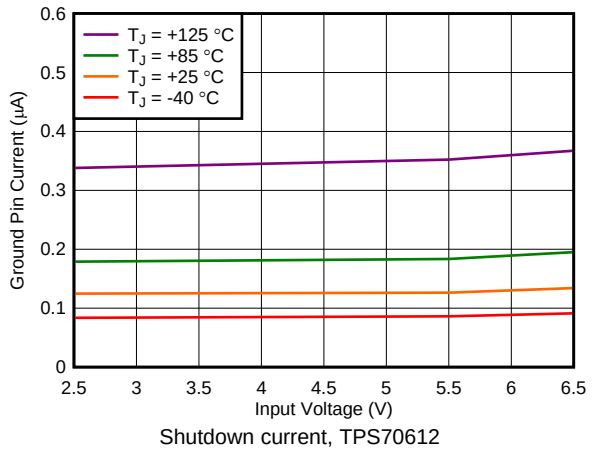


Figure 11. Shutdown Current vs V_{IN} and Temperature

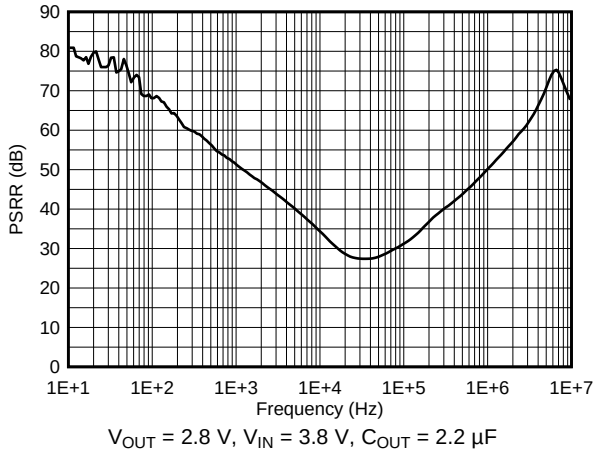
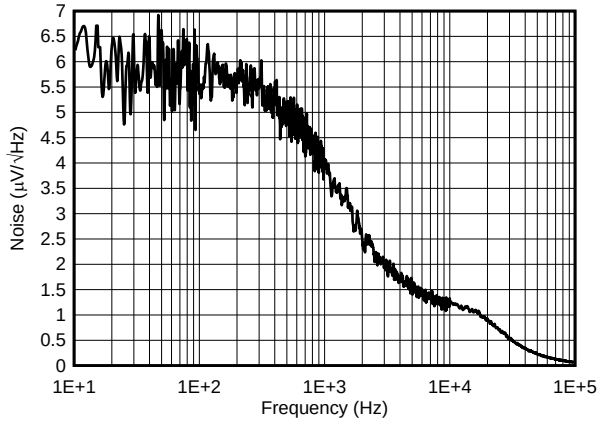


Figure 12. Power-Supply Rejection Ratio vs Frequency

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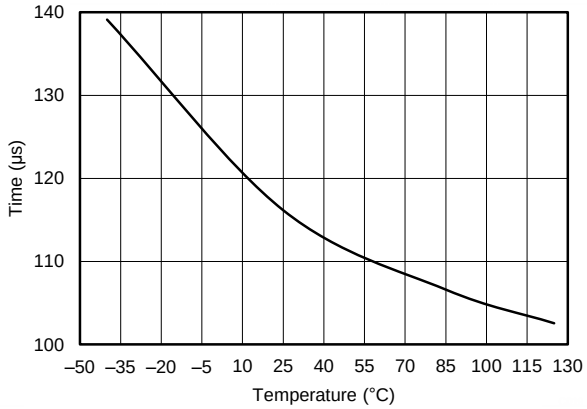
Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), I_{OUT} = 10 mA, V_{EN} = 2 V, C_{OUT} = 2.2 µF, and V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), unless otherwise noted. Typical values are at T_J = 25°C.



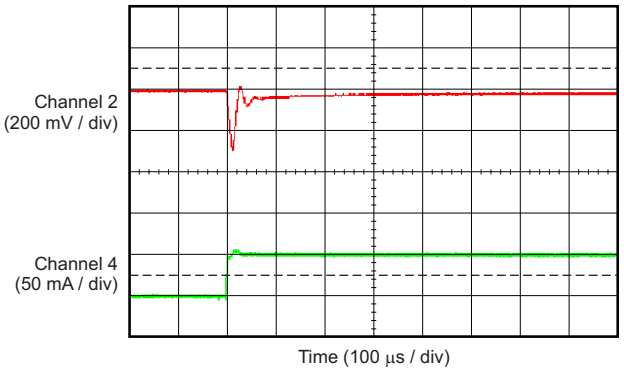
V_{OUT} = 2.8 V

Figure 13. Noise



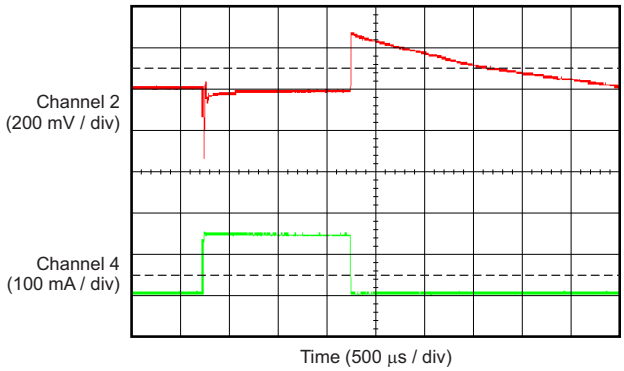
TPS70612

Figure 14. Start-Up Time vs Temperature



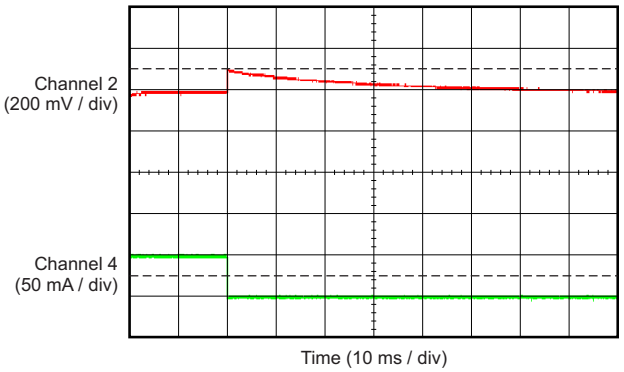
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 2.7 V

Figure 15. TPS70612 Load Transient (0 mA to 50 mA)



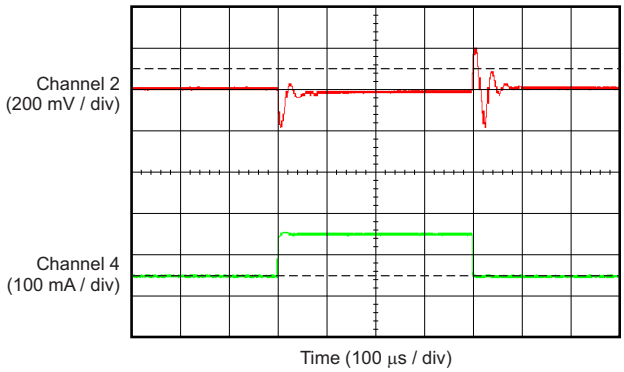
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 2.7 V

Figure 16. TPS70612 Load Transient (1 mA to 150 mA)



Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 2.7 V

Figure 17. TPS70612 Load Transient (50 mA to 0 mA)



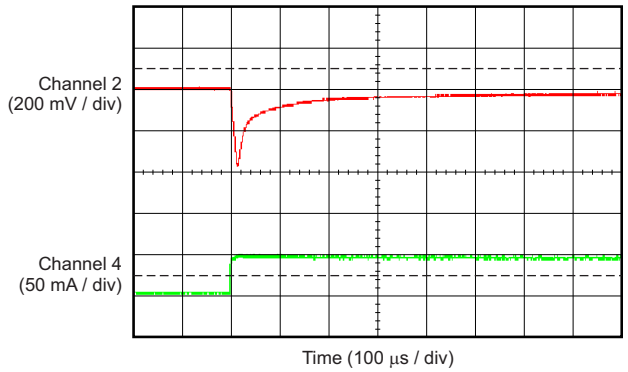
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 2.7 V

Figure 18. TPS70612 Load Transient (50 mA to 150 mA)

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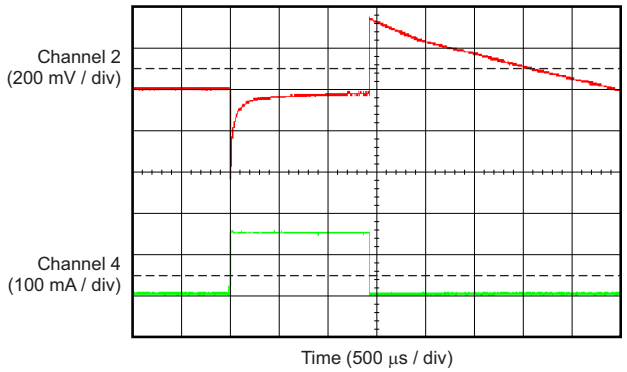
Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), I_{OUT} = 10 mA, V_{EN} = 2 V, C_{OUT} = 2.2 µF, and V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), unless otherwise noted. Typical values are at T_J = 25°C.



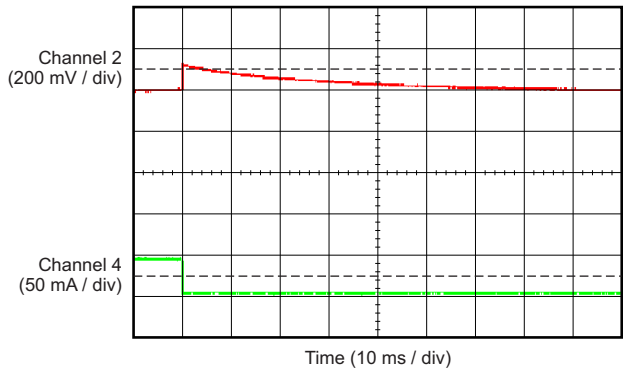
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 4.3 V

Figure 19. TPS70633 Load Transient (0 mA to 50 mA)



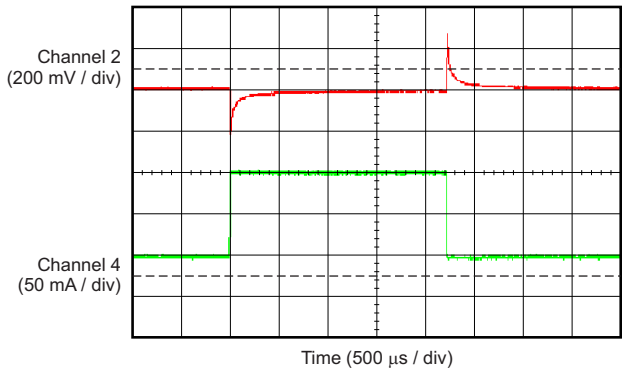
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 4.3 V

Figure 20. TPS70633 Load Transient (1 mA to 150 mA)



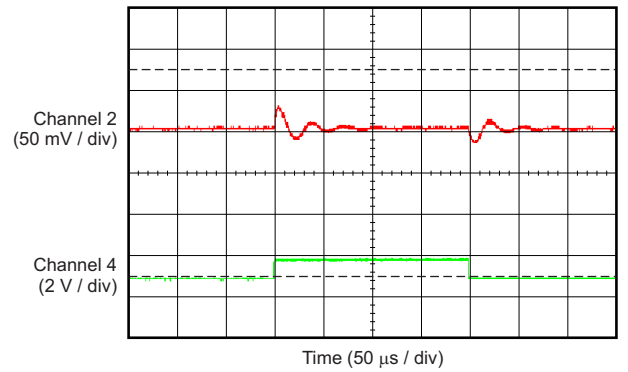
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 4.3 V

Figure 21. TPS70633 Load Transient (50 mA to 0 mA)



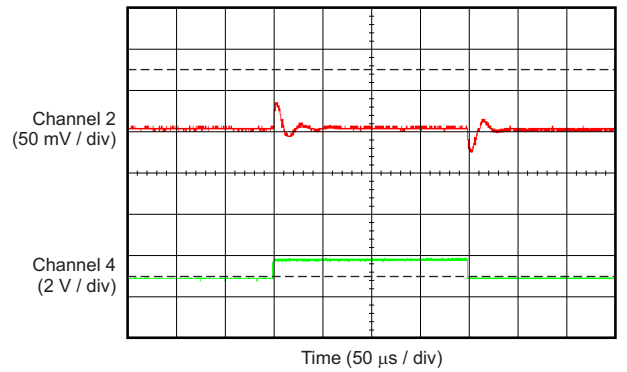
Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 4.3 V

Figure 22. TPS70633 Load Transient (50 mA to 150 mA)



Channel 2 = V_{OUT}, channel 4 = V_{IN}, I_{OUT} = 10 mA

Figure 23. TPS70612 Line Transient (2.7 V to 3.7 V)



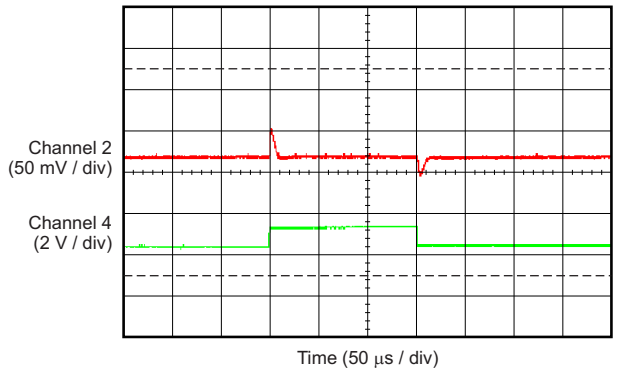
Channel 2 = V_{OUT}, channel 4 = V_{IN}, I_{OUT} = 50 mA

Figure 24. TPS70612 Line Transient (2.7 V to 3.7 V)

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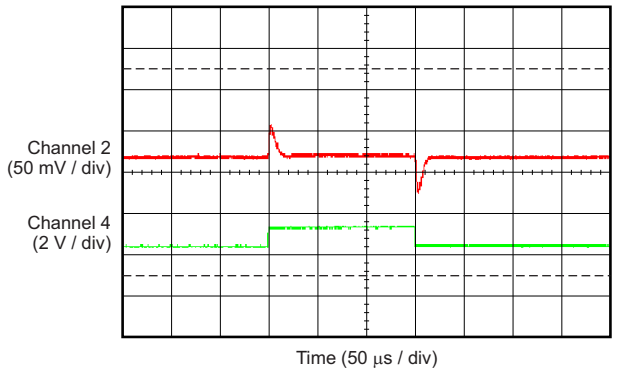
Typical Characteristics (continued)

Over operating temperature range (T_J = –40°C to 125°C), I_{OUT} = 10 mA, V_{EN} = 2 V, C_{OUT} = 2.2 µF, and V_{IN} = $V_{OUT(nom)}$ + 1 V or 2.7 V (whichever is greater), unless otherwise noted. Typical values are at T_J = 25°C.



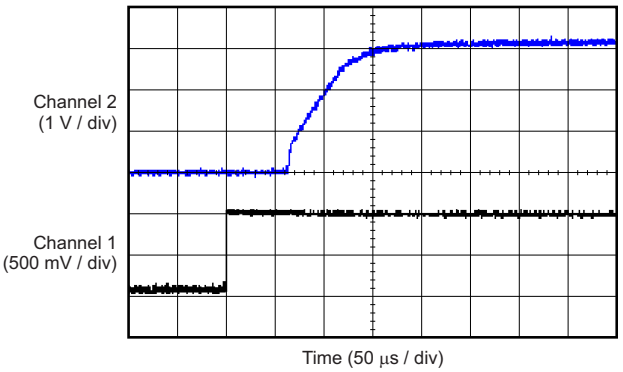
Channel 2 = V_{OUT}, channel 4 = V_{IN}, I_{OUT} = 10 mA

Figure 25. TPS70633 Line Transient (4.3 V to 5.3 V)



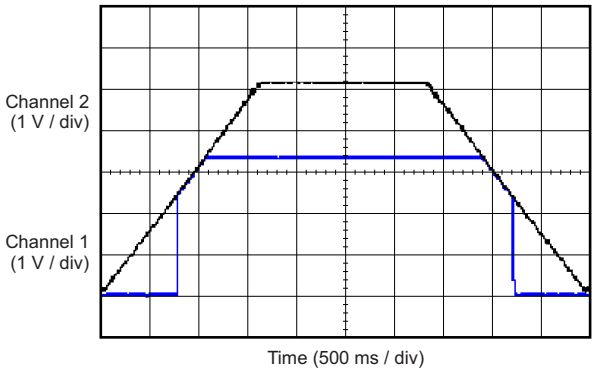
Channel 2 = V_{OUT}, channel 4 = V_{IN}, I_{OUT} = 50 mA

Figure 26. TPS70633 Line Transient (4.3 V to 5.3 V)



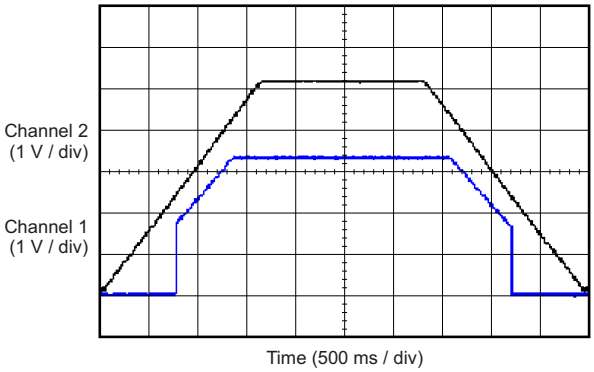
Channel 1 = EN, channel 2 = V_{OUT}, V_{IN} = 4.3 V, C_{OUT} = 2.2 µF, TPS70633

Figure 27. Power-Up with Enable



Channel 1 = V_{IN}, channel 2 = V_{OUT}, I_{OUT} = 3 mA, TPS70633

Figure 28. Power-Up and Power-Down Response



Channel 1 = V_{IN}, channel 2 = V_{OUT}, I_{OUT} = 150 mA, TPS70633

Figure 29. Power-Up and Power-Down Response

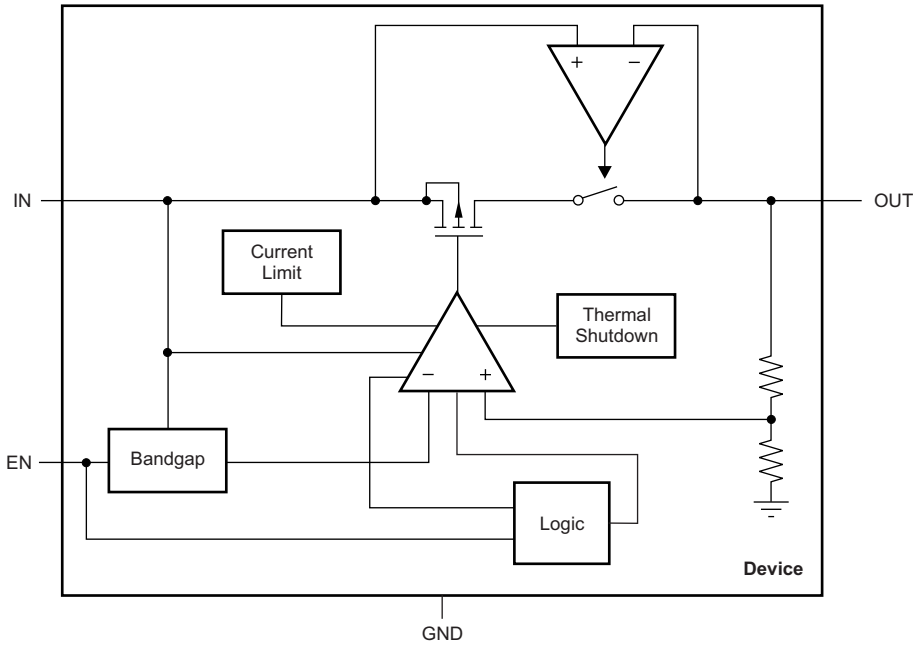
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7 Detailed Description

7.1 Overview

The TPS706 series are ultralow quiescent current, low-dropout (LDO) linear regulators. The TPS706 offers reverse current protection to block any discharge current from the output into the input. The TPS706 also features current limit and thermal shutdown for reliable operation.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Undervoltage Lockout (UVLO)

The TPS706 uses an undervoltage lockout (UVLO) circuit to keep the output shut off until the internal circuitry operates properly.

7.3.2 Shutdown

The enable pin (EN) is active high. Enable the device by forcing the EN pin to exceed $V_{EN(HI)}$ (0.9 V, minimum). Turn off the device by forcing the EN pin to drop below 0.4 V. If shutdown capability is not required, connect EN to IN.

7.3.3 Reverse Current Protection

The TPS706 has integrated reverse current protection. Reverse current protection prevents the flow of current from the OUT pin to the IN pin when output voltage is higher than input voltage. The reverse current protection circuitry places the power path in high impedance when the output voltage is higher than the input voltage. This setting reduces leakage current from the output to the input to 10 nA, typical. The reverse current protection is always active regardless of the enable pin logic state or if the OUT pin voltage is greater than 1.8 V. Reverse current can flow if the output voltage is less than 1.8 V and if input voltage is less than the output voltage.

If voltage is applied to the input pin, then the maximum voltage that can be applied to the OUT pin is the lower of three times the nominal output voltage or 6.5 V. For example, if the 1.2-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 3.6 V. If the 3.3-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 6.5 V.

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Feature Description (continued)

7.3.4 Internal Current Limit

The TPS706 internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. In such a case, the output voltage is not regulated, and can be measured as ($V_{OUT} = I_{LIMIT} \times R_{LOAD}$). The PMOS pass transistor dissipates [($V_{IN} - V_{OUT}$) × I_{LIMIT}] until a thermal shutdown is triggered and the device turns off. When cool, the device is turned on by the internal thermal shutdown circuit. If the fault condition continues, the device cycles between current limit and thermal shutdown; see the *Thermal Information* section for more details.

The TPS706 is characterized over the recommended operating output current range up to 150 mA. The internal current limit begins to limit the output current at a minimum of 200 mA of output current.

7.3.5 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately 158°C, allowing the device to cool. When the junction temperature cools to approximately 140°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit can cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage as a result of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heatsink. For reliable operation, limit junction temperature to 125°C, maximum. To estimate the margin of safety in a complete design (including heatsink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, thermal protection must trigger at least 35°C above the maximum expected ambient condition of the particular application. This configuration produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The TPS706 internal protection circuitry is designed to protect against overload conditions. This circuitry is not intended to replace proper heatsinking. Continuously running the TPS706 into thermal shutdown degrades device reliability.

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7.4 Device Functional Modes

7.4.1 Normal Operation

The device regulates to the nominal output voltage under the following conditions:

- The input voltage is at least as high as $V_{IN(min)}$.
- The input voltage is greater than the nominal output voltage added to the dropout voltage.
- The enable voltage has previously exceeded the enable rising threshold voltage and has not decreased below the enable falling threshold.
- The output current is less than the current limit.
- The device junction temperature is less than the maximum specified junction temperature.

7.4.2 Dropout Operation

If the input voltage is lower than the nominal output voltage plus the specified dropout voltage, but all other conditions are met for normal operation, the device operates in dropout mode. In this mode of operation, the output voltage is the same as the input voltage minus the dropout voltage. The transient performance of the device is significantly degraded because the pass device is in the linear region and no longer controls the current through the LDO. Line or load transients in dropout can result in large output voltage deviations.

7.4.3 Disabled

The device is disabled under the following conditions:

- The enable voltage is less than the enable falling threshold voltage or has not yet exceeded the enable rising threshold.
- The device junction temperature is greater than the thermal shutdown temperature.

Table 1 shows the conditions that lead to the different modes of operation.

Table 1. Device Functional Mode Comparison

OPERATING MODE	PARAMETER			
	V_{IN}	V_{EN}	I_{OUT}	T_J
Normal mode	$V_{IN} > V_{OUT(nom)} + V_{DO}$ and $V_{IN} > V_{IN(min)}$	$V_{EN} > V_{EN(HI)}$	$I_{OUT} < I_{LIM}$	$T_J < 125°C$
Dropout mode	$V_{IN(min)} < V_{IN} < V_{OUT(nom)} + V_{DO}$	$V_{EN} > V_{EN(HI)}$	—	$T_J < 125°C$
Disabled mode (any true condition disables the device)	—	$V_{EN} < V_{EN(low)}$	—	$T_J > 158°C$

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8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The TPS706 consumes low quiescent current and delivers excellent line and load transient performance. This performance, combined with low noise and good PSRR with little (V_{IN} – V_{OUT}) headroom, makes these devices ideal for RF portable applications, current limit, and thermal protection. The TPS706 devices are specified from –40°C to 125°C.

8.1.1 Input and Output Capacitor Considerations

The TPS706 devices are stable with output capacitors with an effective capacitance of 2.0 µF or greater for output voltages below 1.5 V. For output voltages equal or greater than 1.5 V, the minimum effective capacitance for stability is 1.5 µF. The maximum capacitance for stability is 47 µF. The equivalent series resistance (ESR) of the output capacitor must be between 0 Ω and 0.2 Ω for stability.

The effective capacitance is the minimum capacitance value of a capacitor after taking into account variations resulting from tolerances, temperature, and dc bias effects. X5R- and X7R-type ceramic capacitors are recommended because these capacitors have minimal variation in value and ESR over temperature.

Although an input capacitor is not required for stability, good analog design practice is to connect a 0.1-µF to 2.2-µF capacitor from IN to GND. This capacitor counteracts reactive input sources and improves transient response, input ripple rejection, and PSRR.

8.1.2 Dropout Voltage

The TPS706 uses a PMOS pass transistor to achieve low dropout. When (V_{IN} – V_{OUT}) is less than the dropout voltage (V_{DO}), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the $R_{DS(ON)}$ of the PMOS pass element. V_{DO} approximately scales with the output current because the PMOS device functions like a resistor in dropout.

The ground pin current of many linear voltage regulators increases substantially when the device is operated in dropout. This increase in ground pin current while operating in dropout can be several orders of magnitude larger than when the device is not in dropout. The TPS706 employs a special control loop that limits the increase in ground pin current while operating in dropout. This functionality allows for the most efficient operation while in dropout conditions that can greatly increase battery run times.

8.1.3 Transient Response

As with any regulator, increasing the output capacitor size reduces over- and undershoot magnitude, but increases transient response duration.

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8.2 Typical Application

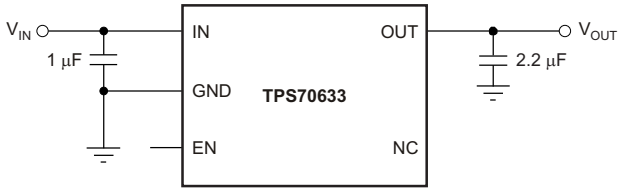


Figure 30. 3.3-V, Low-I_Q Rail

8.2.1 Design Requirements

Table 2 summarizes the design requirements for Figure 30.

Table 2. Design Requirements for a 3.3-V, Low-I_Q Rail Application

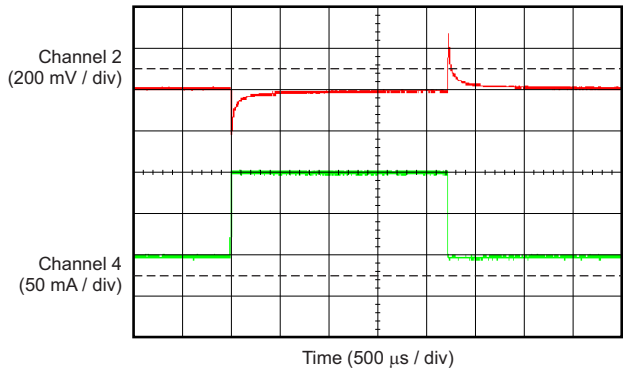
PARAMETER	DESIGN SPECIFICATION
V_{IN}	4.3 V
V_{OUT}	3.3 V
$I_{(IN)}$ (no load)	< 5 µA
I_{OUT} (max)	150 mA

8.2.2 Detailed Design Procedure

Select a 2.2-µF, 10-V X7R output capacitor to satisfy the minimum output capacitance requirement with a 3.3-V dc bias.

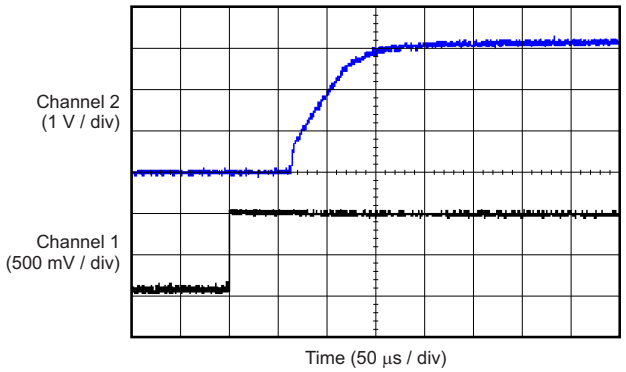
Select a 1.0-µF, 6.3-V X7R input capacitor to provide input noise filtering and eliminate high-frequency voltage transients.

8.2.3 Application Curves



Channel 2 = V_{OUT}, channel 4 = I_{OUT}, V_{IN} = 4.3 V

Figure 31. TPS70633 Load Transient (50 mA to 150 mA)



Channel 1 = EN, channel 2 = V_{OUT}, V_{IN} = 4.3 V, C_{OUT} = 2.2 µF, TPS70633

Figure 32. Power-Up with Enable

9 Power Supply Recommendations

This device is designed to operate with an input supply range of 2.7 V to 6.5 V. The input voltage range must provide adequate headroom in order for the device to have a regulated output. This input supply must be well-regulated and stable. If the input supply is noisy, additional input capacitors with low ESR can help improve the output noise performance.

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10 Layout

10.1 Layout Guidelines

10.1.1 Board Layout Recommendations to Improve PSRR and Noise Performance

Input and output capacitors must be placed as close to the device pins as possible. To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for V_{IN} and V_{OUT}, with the ground plane connected only at the device GND pin. In addition, the output capacitor ground connection must be connected directly to the device GND pin.

10.1.2 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. Performance data for JEDEC low- and high-K boards are given in the *Thermal Information*. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heatsink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation (P_D) can be approximated by the product of the output current times the voltage drop across the output pass element (V_{IN} to V_{OUT}), as shown in Equation 1.

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (1)$$

Figure 33 shows the maximum ambient temperature versus the power dissipation of the TPS706. This figure assumes the device is soldered on a JEDEC standard, high-K layout with no airflow over the board. Actual board thermal impedances vary widely. If the application requires high power dissipation, having a thorough understanding of the board temperature and thermal impedances is helpful to ensure the TPS706 does not operate above a junction temperature of 125°C.

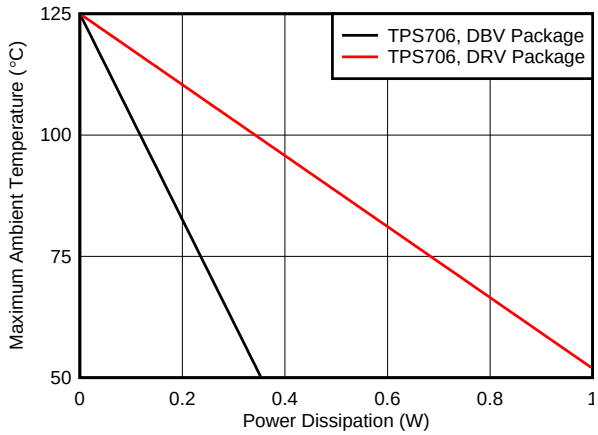


Figure 33. Maximum Ambient Temperature vs Device Power Dissipation

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Layout Guidelines (continued)

Estimating the junction temperature can be done by using the thermal metrics Ψ_{JT} and Ψ_{JB}, shown in the *Thermal Information*. These metrics are a more accurate representation of the heat transfer characteristics of the die and the package than $R_{\theta JA}$. The junction temperature can be estimated with Equation 2.

$$\Psi_{JT}: \quad T_J = T_T + \Psi_{JT} \bullet P_D$$

$$\Psi_{JB}: \quad T_J = T_B + \Psi_{JB} \bullet P_D \tag{2}$$

where:

- P_D is the power dissipation shown by Equation 1,
- T_T is the temperature at the center-top of the IC package,
- T_B is the PCB temperature measured 1 mm away from the IC package *on the PCB surface*.

NOTE

Both T_T and T_B can be measured on actual application boards using a thermo-gun (an infrared thermometer).

For more information about measuring T_T and T_B, see the application note *Using New Thermal Metrics* (SBVA025), available for download at www.ti.com.

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10.2 Layout Examples

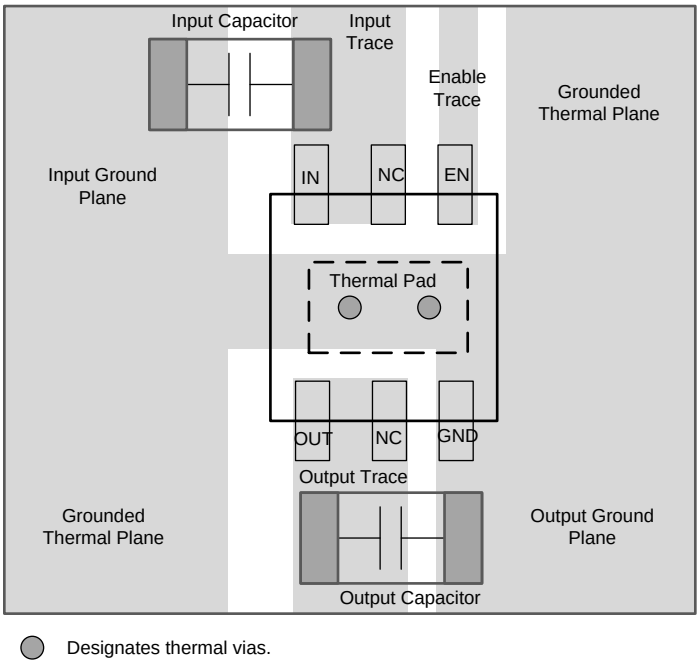


Figure 34. WSON Layout Example

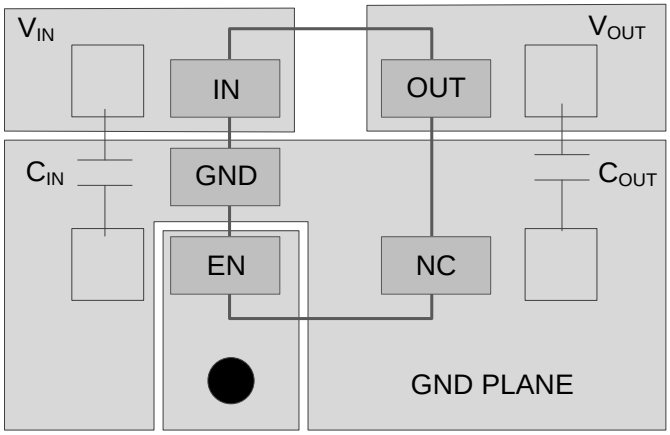


Figure 35. SOT23-5 Layout Example

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11 Device and Documentation Support

11.1 Device Support

11.1.1 Development Support

11.1.1.1 Spice Models

Computer simulation of circuit performance using SPICE is often useful when analyzing the performance of analog circuits and systems. A SPICE model for the TPS706 is available through the product folders under *Simulation Models*.

11.1.2 Device Nomenclature

Table 3. Device Nomenclature(1)

PRODUCT	V_{OUT}
TPS706**xx** ***yyy z***	**xx** is the nominal output voltage. For output voltages with a resolution of 100 mV, two digits are used in the ordering number; otherwise, three digits are used (for example, 28 = 2.8 V). **yyy** is the package designator. **z** is the tape and reel quantity (R = 3000, T = 250).

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

11.2 Documentation Support

11.2.1 Related Documentation

SBVU002 — DEM-SOT23LDO Demonstration Fixture

SBVA025 — *Using New Thermal Metrics*

11.3 Trademarks

All trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70612DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70612DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJC
TPS70615DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVRG4	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVRG4.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVRG4.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70615DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIW
TPS70618DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70618DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70618DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIX
TPS70625DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVRG4	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVRG4.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVRG4.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVTG4	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVTG4.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70625DRVTG4.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIY
TPS70628DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70628DBVRG4	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVRG4.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVRG4.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70628DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJU
TPS70630DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70630DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SIZ
TPS70633DBVR	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVR.A	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVR.B	Active	Production	SOT-23 (DBV) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVT	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVT.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVT.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVTG4	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS70633DBVTG4.A	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DBVTG4.B	Active	Production	SOT-23 (DBV) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVR	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVR.A	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVR.B	Active	Production	WSON (DRV) | 6	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVT	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVT.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVT.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVTG4	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVTG4.A	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA
TPS70633DRVTG4.B	Active	Production	WSON (DRV) | 6	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SJA

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

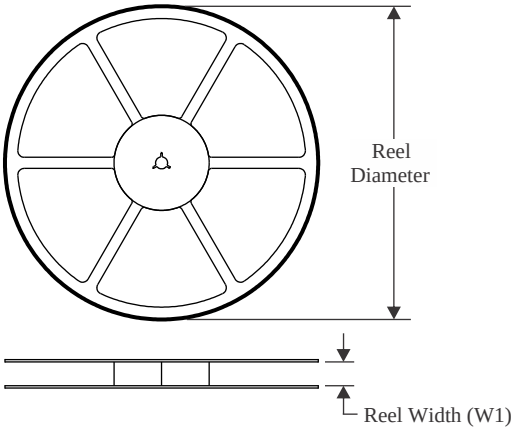
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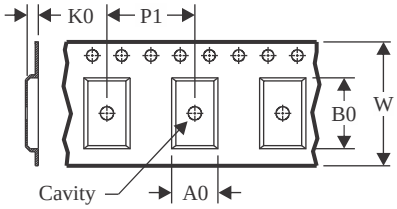
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TAPE AND REEL INFORMATION

REEL DIMENSIONS

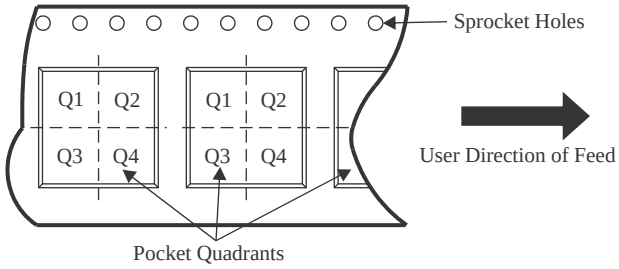


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

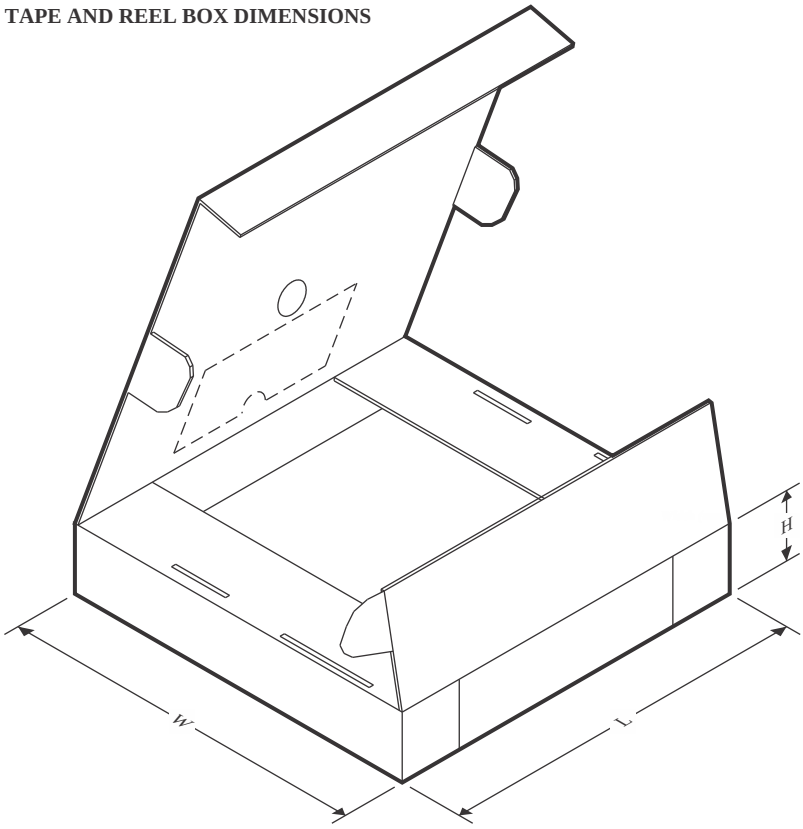


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS70612DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70612DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70612DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70612DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70612DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70615DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70615DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70615DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70615DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70615DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70615DRVRG4	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70615DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70618DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70618DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70618DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70618DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS70618DRVR	WSON	DRV	6	3000	178.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70618DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70618DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70625DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70625DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70625DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70625DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70625DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70625DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70625DRVTG4	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70628DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70628DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70628DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70628DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70628DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70628DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70630DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70630DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70630DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70630DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70630DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70630DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70633DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70633DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70633DBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS70633DBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70633DBVTG4	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TPS70633DRVR	WSON	DRV	6	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70633DRVT	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
TPS70633DRVTG4	WSON	DRV	6	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS70612DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70612DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70612DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70612DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70612DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70615DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70615DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70615DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70615DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70615DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70615DRVRG4	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70615DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70618DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70618DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70618DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70618DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70618DRVR	WSON	DRV	6	3000	208.0	191.0	35.0
TPS70618DRVR	WSON	DRV	6	3000	182.0	182.0	20.0

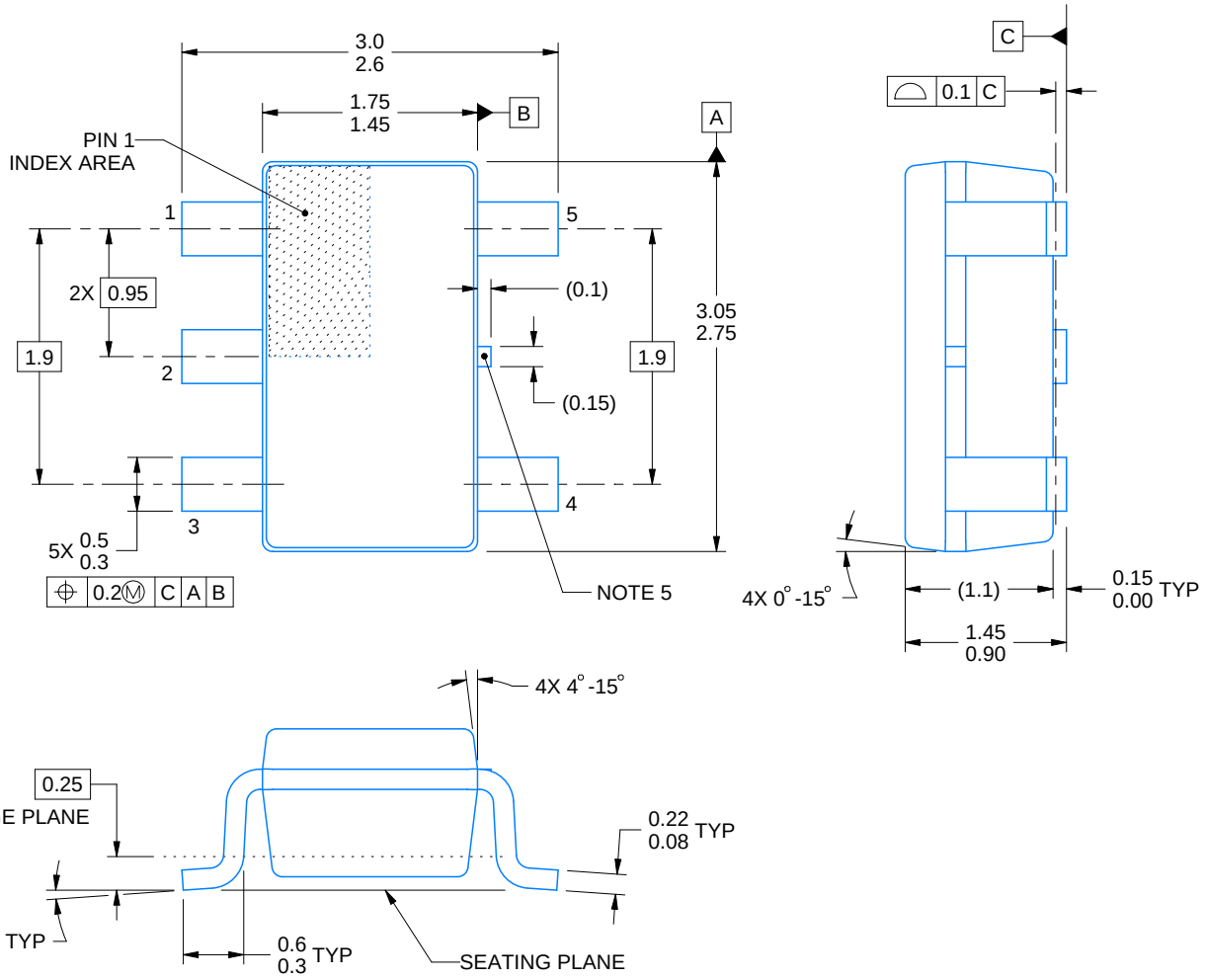
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS70618DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70625DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70625DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70625DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70625DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70625DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70625DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70625DRVTG4	WSON	DRV	6	250	182.0	182.0	20.0
TPS70628DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70628DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70628DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70628DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70628DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70628DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70630DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70630DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70630DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70630DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70630DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70630DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70633DBVR	SOT-23	DBV	5	3000	210.0	185.0	35.0
TPS70633DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS70633DBVT	SOT-23	DBV	5	250	210.0	185.0	35.0
TPS70633DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70633DBVTG4	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS70633DRVR	WSON	DRV	6	3000	182.0	182.0	20.0
TPS70633DRVT	WSON	DRV	6	250	182.0	182.0	20.0
TPS70633DRVTG4	WSON	DRV	6	250	182.0	182.0	20.0

PACKAGE OUTLINE

DBV0005A

SOT-23 - 1.45 mm max height

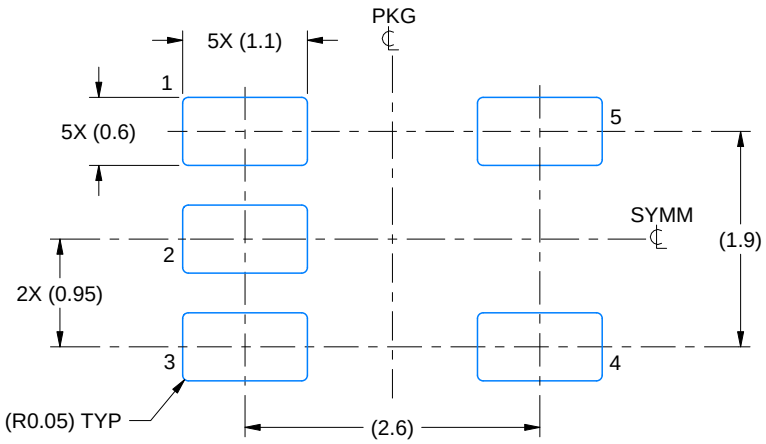
SMALL OUTLINE TRANSISTOR



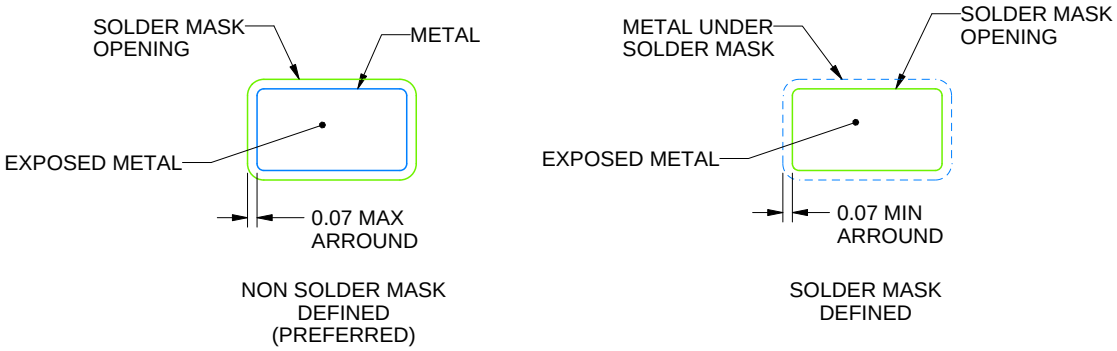
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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X

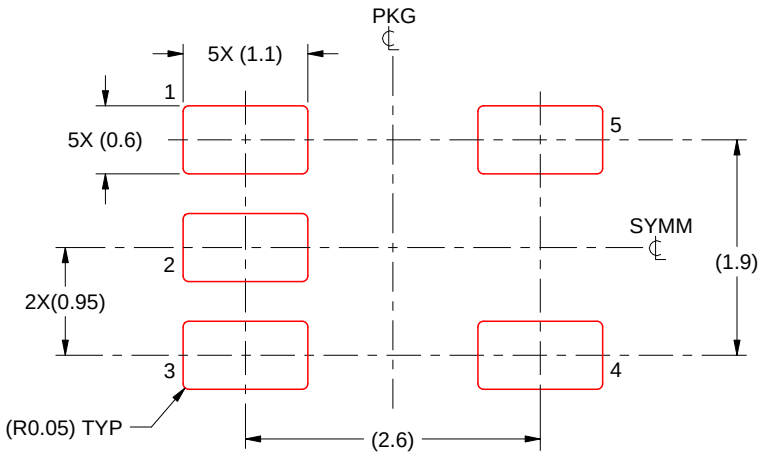


SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

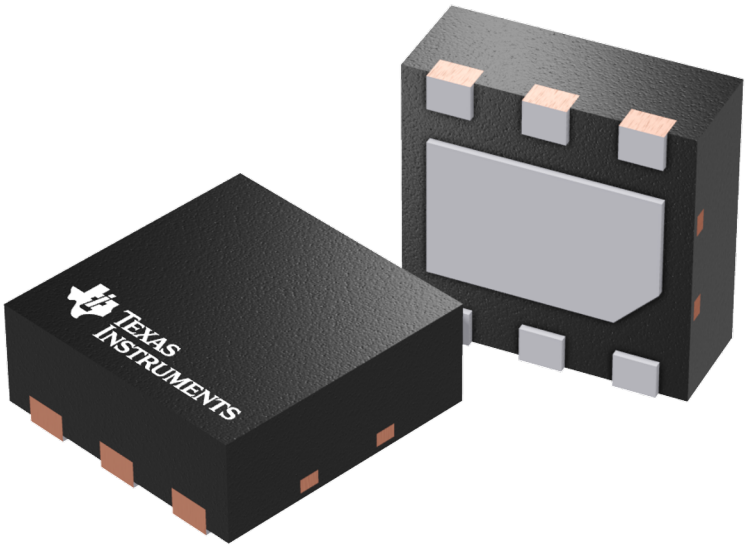
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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

DRV 6 WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

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Last updated 10/2025